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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of

Takeshi OOTSUKA, et al.

Date: January 12, 2005

Serial No.: 10/668,483

Group Art Unit: 2823

Filed: September 22, 2003

Examiner: Julio J. MALDONADO

For: BONDING METHOD, BONDING STAGE AND ELECTRONIC
COMPONENT PACKAGING APPARATUSMail Stop Amentment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**RESPONSE TO RESTRICTION REQUIREMENT**
REMARKS/ARGUMENT

This Response is filed in reply to the Restriction Requirement mailed September 2, 2004. Applicant elects the invention of Group I: Claims 3-8, drawn to a bonding stage that packages an electronic component, classified in Class 156, subclass 379.6.

Applicant reserves the right to file a divisional application directed to the subject matter covered in the non-elected claims.

Early and favorable consideration of the present application is earnestly solicited.

If this communication is filed after the statutory time period had elapsed and no separate Petition is enclosed, the Commissioner for Patents is petitioned, under 37 C.F.R. §1.136(a), to extend the time for filing a response to the outstanding Office Action by the number of months which will avoid abandonment under 37 C.F.R. §1.135. The fee under 37 C.F.R. § 1.17 should be charged to our Deposit Account No. 15-0700.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on January 12, 2005

Max Moskowitz

Name of applicant, assignee or
Registered RepresentativeSignature
January 12, 2005

Date of Signature

Respectfully submitted,

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